Fujitsu’s Commitment

• Advantest and Fujitsu Microelectronics form joint venture in e-beam direct write manufacturing called e-Shuttle – November 2006

• e-Shuttle starts production with the first Advantest CP-based tool – November 2007

• Fujitsu and e-Shuttle SPIE paper on e-beam maskless prototype to optical volume manufacturing – February 2008
  – E-beam based prototypes are compatible with later volume production with light

• e-Shuttle starts production with the second Advantest tool – October 2008
October 2008
Second Advantest tool in production in Mie factory
October 2008
Collaboration to prove DFEB benefits
Results Expected in 2009

- Fujitsu 65-nm low-power test chip
- e-Shuttle to manufacture the test chip
- Customer engagements to follow